



# SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	24.000000 MHz
PRODUCT TYPE	TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL
SPEC. NO. ( P/N )	FL2400063
CUSTOMER P/N	
ISSUE DATE	January 25, 2018
VERSION	E

APPROVED	PREPARED	QA
Brenda	Kelly	Dong Jang

### **Diodes Incorporated**

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- \*Pb-free
- \*RoHS Compliant
- \*HF-Halogen Free
- \*REACH Compliant

E0-R-4-014 Rev. F

FL2400063

VER. E 25-Jan-18

### **VERSION HISTORY**

Version No.	Version Date	Description	Notes
А	Jul.28,2009	Initial Release	
В	Dec.7,2010	New Logo	
С	Jan.16,2013	Updated Suggested IR Reflow Profile & Format	
D	Jan.15,2016	Updated Mechanical Drawing	
Е	Jan.25,2018	Updated logo	

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### **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	24.000000	MHz	
Mode of Oscillation	МО	AT Cut-Fundamental		
Calibration Load Capacitance	CL	8	pF	
Calibration Tolerance	FL	±15	ppm	at 25℃±3℃
Operating Temperature Range	TR	-40 to +85	.C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±25	ppm	Reference to the Frequency at 25℃
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	50	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25℃		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	.C	
Insulation Resistance		500	ΜΩ	Min

★ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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#### **RELIABILITY SPECIFICATIONS**

#### **MECHANICAL AND ENVIRONMENTAL RATINGS:**

a) FINE LEAK TEST: JESD22-A109 (Condition 1A)

b) GROSS LEAK TEST: JESD22-A109 (Condition C)

c) MOISTURE RESISTANCE: JESD22-A113

d) SHOCK: JESD22-B104 (Condition B)

e) SOLDERABILITY: (RoHS version): J-STD-002

f) VIBRATION: JESD22-B103

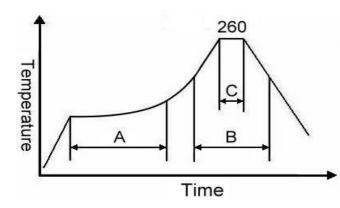
g) SOLVENT RESISTANCE: JESD22-B107

h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

Note:

#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



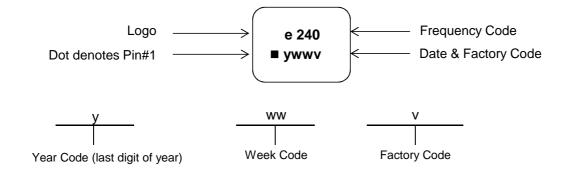
	Stage	Temperature	Time		
Α	Preheat	150~200°C	60~120 Sec		
В	Primary Heat	217°C	60~150 Sec		
С	Peak	260°C	10 Sec		

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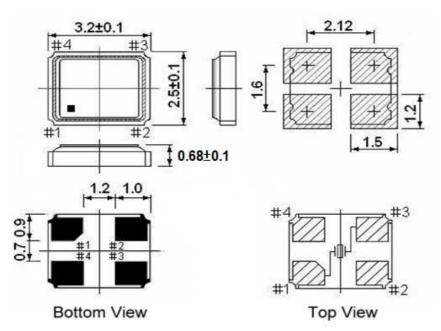
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#### **MARKING**



### MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

#### **Recommended Land Pattern**



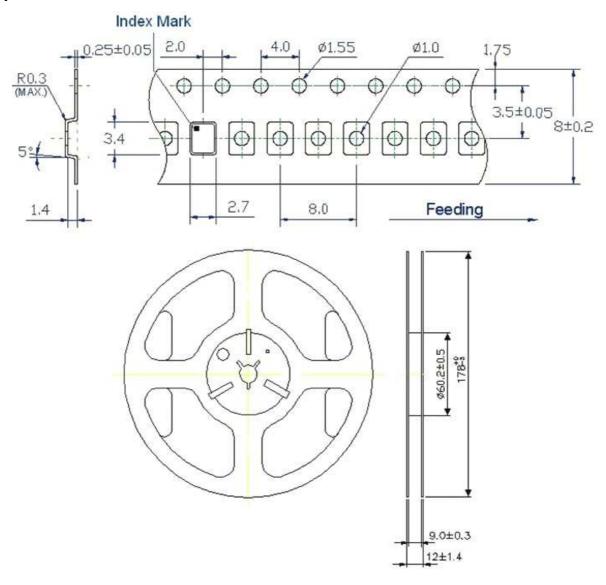
\*\* Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

#### Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
  Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.

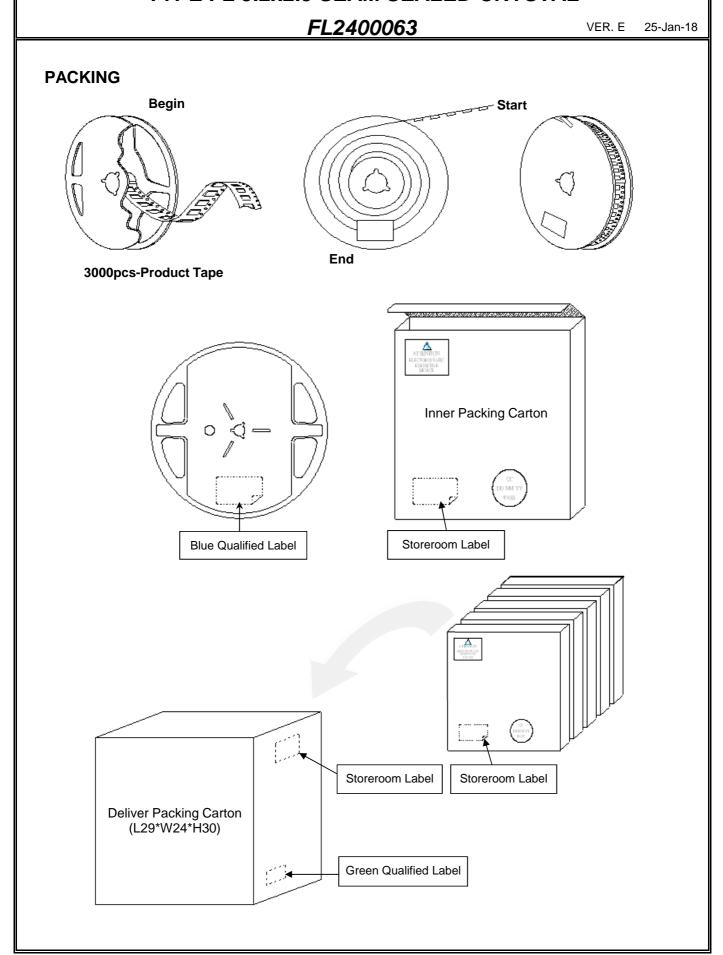
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### Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

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